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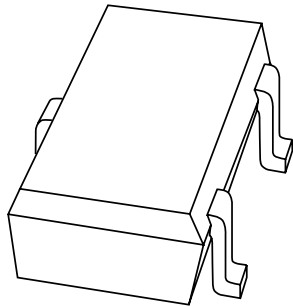
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Kind regards,

Team Nexperia

DATA SHEET



PMST2369 NPN switching transistor

Product data sheet
Supersedes data of 1997 May 05

1999 Apr 22



NPN switching transistor

PMST2369

FEATURES

- Low current (max. 200 mA)
- Low voltage (max. 15 V).

APPLICATIONS

- High-speed switching applications, primarily in portable and consumer equipment.

DESCRIPTION

NPN switching transistor in a SOT323 plastic package.

MARKING

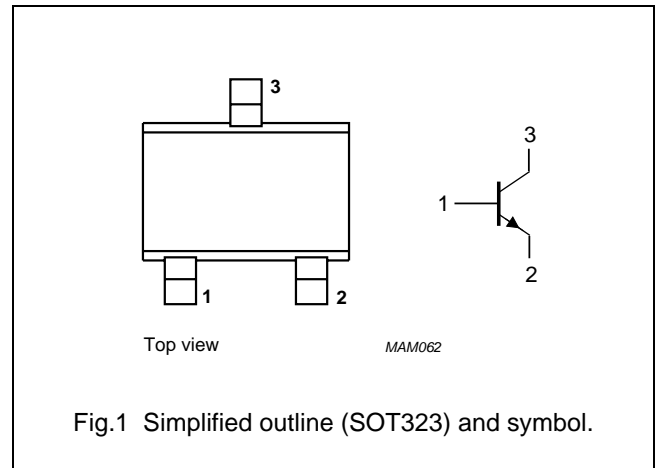
| TYPE NUMBER | MARKING CODE ⁽¹⁾ |
|-------------|-----------------------------|
| PMST2369 | *1J |

Note

- * = - : Made in Hong Kong.
* = t : Made in Malaysia.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | base |
| 2 | emitter |
| 3 | collector |



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|----------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | – | 40 | V |
| V _{CEO} | collector-emitter voltage | open base | – | 15 | V |
| V _{EBO} | emitter-base voltage | open collector | – | 5 | V |
| I _C | collector current (DC) | | – | 200 | mA |
| I _{CM} | peak collector current | t _p ≤ 10 μs | – | 300 | mA |
| I _{BM} | peak base current | | – | 100 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; note 1 | – | 200 | mW |
| T _{stg} | storage temperature | | –65 | +150 | °C |
| T _j | junction temperature | | – | 150 | °C |
| T _{amb} | operating ambient temperature | | –65 | +150 | °C |

Note

1. Transistor mounted on an FR4 printed-circuit board.

NPN switching transistor

PMST2369

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|---|------------|-------|------|
| $R_{th\ j-a}$ | thermal resistance from junction to ambient | note 1 | 625 | K/W |

Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

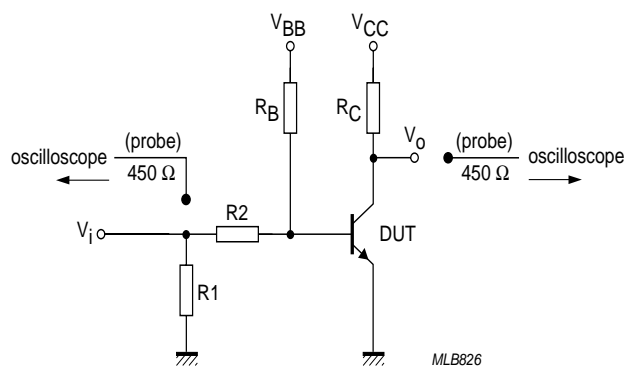
| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--|--------------------------------------|---|------|------|---------------|
| I_{CBO} | collector cut-off current | $I_E = 0; V_{CB} = 20\text{ V}$ | – | 400 | nA |
| | | $I_E = 0; V_{CB} = 20\text{ V}; T_j = 125\text{ °C}$ | – | 30 | μA |
| I_{EBO} | emitter cut-off current | $I_C = 0; V_{EB} = 4\text{ V}$ | – | 100 | nA |
| h_{FE} | DC current gain | $I_C = 10\text{ mA}; V_{CE} = 1\text{ V}$ | 40 | 120 | |
| | | $I_C = 10\text{ mA}; V_{CE} = 1\text{ V}; T_{amb} = -55\text{ °C}$ | 20 | – | |
| | | $I_C = 100\text{ mA}; V_{CE} = 2\text{ V}; \text{note 1}$ | 20 | – | |
| V_{CEsat} | collector-emitter saturation voltage | $I_C = 10\text{ mA}; I_B = 1\text{ mA}$ | – | 250 | mV |
| V_{BEsat} | base-emitter saturation voltage | $I_C = 10\text{ mA}; I_B = 1\text{ mA}$ | 700 | 850 | mV |
| C_c | collector capacitance | $I_E = i_e = 0; V_{CB} = 5\text{ V}; f = 1\text{ MHz}$ | – | 4 | pF |
| f_T | transition frequency | $I_C = 10\text{ mA}; V_{CE} = 10\text{ V}; f = 100\text{ MHz}$ | 500 | – | MHz |
| Switching times (between 10% and 90% levels); (see Fig.2) | | | | | |
| t_{on} | turn-on time | $I_{Con} = 10\text{ mA}; I_{Bon} = 3\text{ mA};$ $I_{Boff} = -1.5\text{ mA}$ | – | 10 | ns |
| t_d | delay time | | – | 4 | ns |
| t_r | rise time | | – | 6 | ns |
| t_{off} | turn-off time | | – | 20 | ns |
| t_s | storage time | | – | 10 | ns |
| t_f | fall time | | – | 10 | ns |

Note

1. Pulse test: $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$.

NPN switching transistor

PMST2369



$V_i = 0.5 \text{ V to } 4.2 \text{ V}$; $T = 500 \text{ } \mu\text{s}$; $t_p = 10 \text{ } \mu\text{s}$; $t_r = t_f \leq 1 \text{ ns}$.

$R_1 = 56 \text{ } \Omega$; $R_2 = 1 \text{ k}\Omega$; $R_B = 1 \text{ k}\Omega$; $R_C = 270 \text{ } \Omega$.

$V_{BB} = 0.2 \text{ V}$; $V_{CC} = 2.7 \text{ V}$.

Oscilloscope: input impedance $Z_i = 50 \text{ } \Omega$.

Fig.2 Test circuit for switching times.

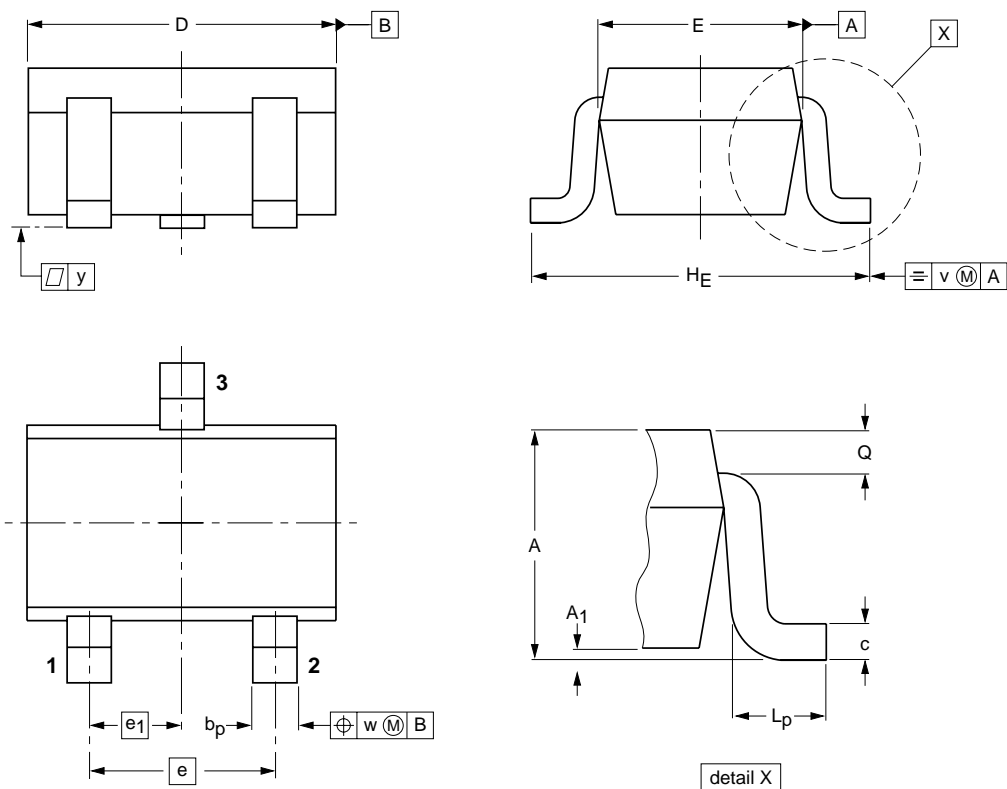
NPN switching transistor

PMST2369

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT323



DIMENSIONS (mm are the original dimensions)

| UNIT | A | A ₁ max | b _p | c | D | E | e | e ₁ | H _E | L _p | Q | v | w |
|------|------------|-----------------------|----------------|--------------|------------|--------------|-----|----------------|----------------|----------------|--------------|-----|-----|
| mm | 1.1 0.8 | 0.1 | 0.4 0.3 | 0.25 0.10 | 2.2 1.8 | 1.35 1.15 | 1.3 | 0.65 | 2.2 2.0 | 0.45 0.15 | 0.23 0.13 | 0.2 | 0.2 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|--------------------|------------|-------|-------|--|------------------------|------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT323 | | | SC-70 | | | 97-02-28 |

NPN switching transistor

PMST2369

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|--------------------------------|-------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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NXP Semiconductors

Customer notification

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Contact information

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